

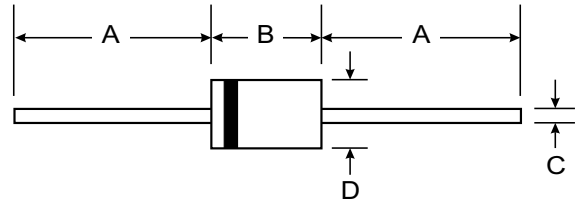
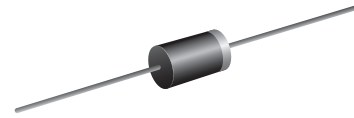
**VOLTAGE RANGE: 100 - 1000V**  
**CURRENT: 1.1-2.0 A**

### Features

- Low cost
- Diffused junction
- Low leakage
- Low forward voltage drop
- Easily cleaned with freon, alcohol, Isopropanol and similar solvents
- The plastic material carries U/L recognition 94V-0

### Mechanical Data

- Case : DO-15 Molded plastic
- Epoxy : UL94V-0 rate flame retardant
- Lead : Axial lead solderable per MIL-STD-202, Method 208 guaranteed
- Polarity : Color band denotes cathode end
- Mounting position : Any
- Weight : 0.465 gram



DO-15		
Dim	Min	Max
A	25.40	—
B	5.50	7.62
C	0.686	0.889
D	2.60	3.60
All Dimensions in mm		



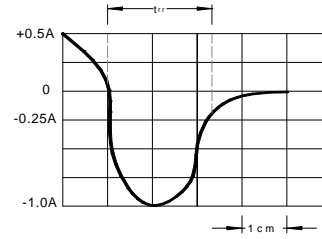
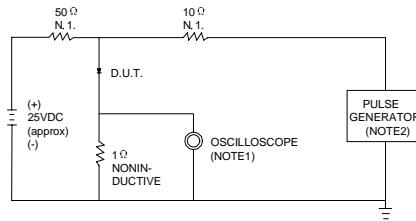
### Maximum Ratings and Electrical Characteristics T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	RU3YX	RU3	RU3A	RU3B	RU3C	Unit
Maximum peak repetitive reverse voltage	V <sub>RRM</sub>	100	400	600	800	1000	V
Maximum RMS voltage	V <sub>RMS</sub>	70	280	420	560	700	V
Maximum DC blocking voltage	V <sub>DC</sub>	100	400	600	800	1000	V
Maximum average forward rectified current 9.5mm lead length, @T <sub>A</sub> =75°C	I <sub>F(AV)</sub>	2.0	1.5		1.1	1.5	A
Peak forward surge current 10ms single half-sine-wave superimposed on rated load @T <sub>J</sub> =125°C	I <sub>FSM</sub>	50.0	20.0				A
Maximum instantaneous forward voltage @ I <sub>F</sub> =I <sub>F(AV)</sub>	V <sub>F</sub>	0.95	1.5			2.5	V
Maximum reverse current @T <sub>A</sub> =25°C at rated DC blocking voltage @T <sub>A</sub> =100°C	I <sub>R</sub>	10.0				μA	
		300.0	400.0				
Maximum reverse recovery time (Note1)	t <sub>rr</sub>	50	100				ns
Typical junction capacitance (Note2)	C <sub>J</sub>	50		30			pF
Typical thermal resistance (Note3)	R <sub>θJL</sub>	12					°C/W
Operating junction temperature range	T <sub>J</sub>	- 55 ----- + 150					°C
Storage temperature range	T <sub>STG</sub>	- 55 ----- + 150					°C

NOTE: 1. Measured with I<sub>F</sub>=0.5A, I<sub>R</sub>=1A, I<sub>rr</sub>=0.25A  
 2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.  
 3. Thermal resistance junction to ambient.

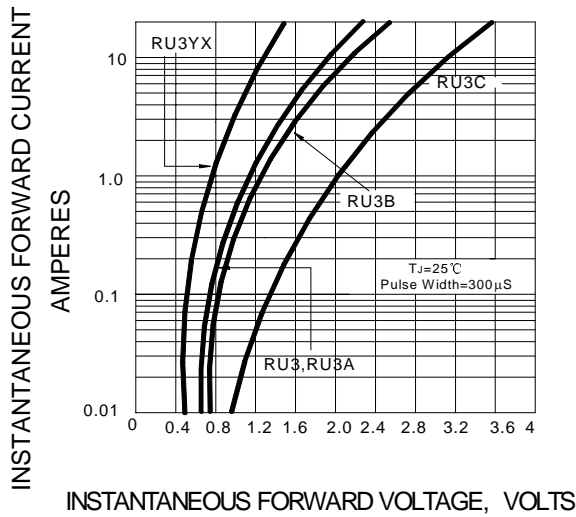
**FIG.1 – TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC**



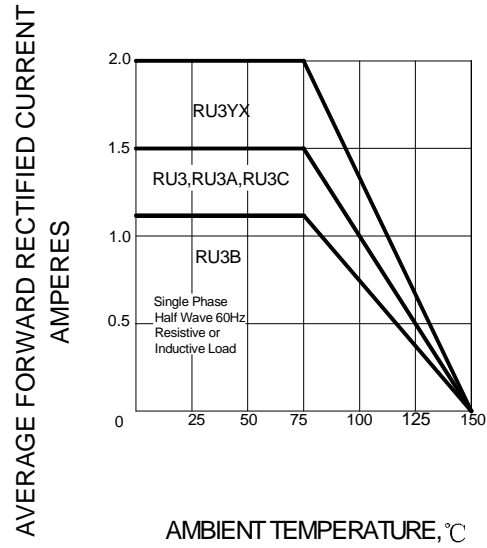
NOTES: 1. RISE TIME = 7ns MAX INPUT IMPEDANCE =  $1M\Omega$ , 22pF.  
 2. RISE TIME = 10ns MAX SOURCE IMPEDANCE = 50  $\Omega$ .

SET TIME BASE FOR 10/20 ns/cm

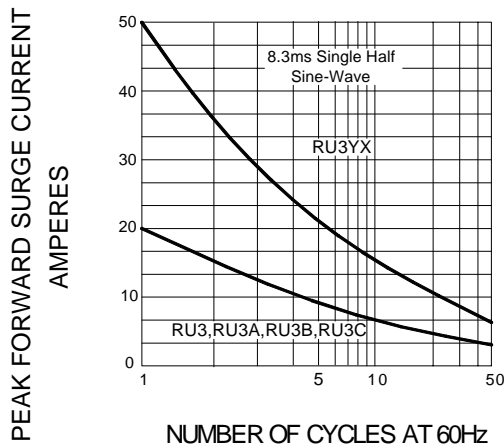
**FIG.2 – TYPICAL FORWARD CHARACTERISTIC**



**FIG.3 – FORWARD DERATING CURVE**



**FIG.4 – PEAK FORWARD SURGE CURRENT**



**FIG.5 – TYPICAL JUNCTION CAPACITANCE**

